



20V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on) max	ID MAX @ T _A = +25°C	
-20V	495mΩ @ V _{GS} = -4.5V	-0.77A	
	690mΩ @ V _{GS} = -2.5V	-0.67A	
	960mΩ @ V _{GS} = -1.8V	-0.57A	

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Portable Electronics

Features and Benefits

- Footprint of just 0.6mm² 13 Times Smaller than SOT23
- 0.4mm Profile Ideal for Low Profile Applications
- Low Gate Threshold Voltage
- Fast Switching Speed
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

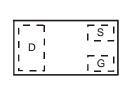
- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202. Method 208 @4
- Weight: 0.001 grams (Approximate)



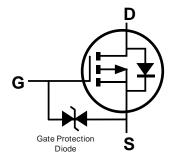




Bottom View



Top View Internal Schematic



Equivalent Circuit

Ordering Information (Note 4)

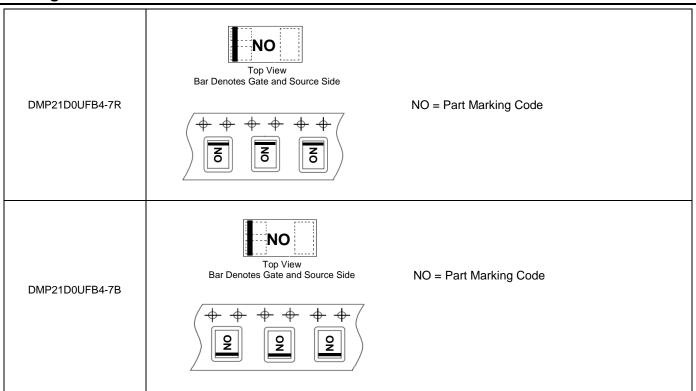
Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Tape Pitch (mm)	Quantity per Reel
DMP21D0UFB4-7R	NO	7	8	4	3,000
DMP21D0UFB4-7B	NO	7	8	2	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information





Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	-20	V
Gate-Source Voltage			Vgss	±8	V
Continuous Drain Current	0	$T_A = +25^{\circ}C \text{ (Note 5)}$		-0.77	А
	Steady State	T _A = +85°C (Note 5)	lD	-0.55	
	State	$T_A = +25^{\circ}C$ (Note 6)]	-1.17	
Pulsed Drain Current (Note 7)			I _{DM}	-5.0	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	0.43	W
Power Dissipation (Note 6)	PD	0.99	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	293	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	126	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
- 7. Device mounted on minimum recommended pad layout test board, $10\mu s$ pulse duty cycle = 1%.

Thermal Characteristics

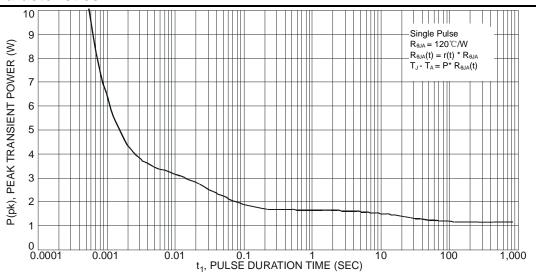


Fig. 1 Single Pulse Maximum Power Dissipation

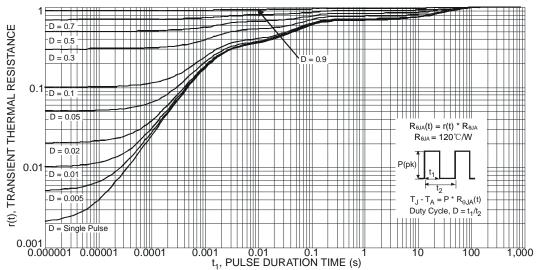


Fig. 2 Transient Thermal Response

DMP21D0UFB4 Datasheet number: DS35279 Rev. 5 - 2



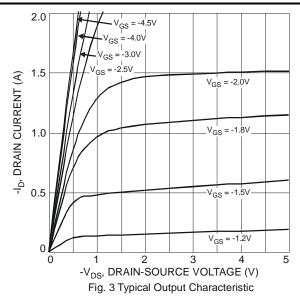
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

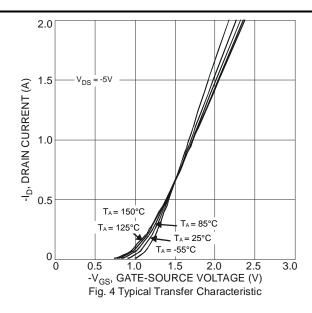
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	-1	μA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	-0.5	-0.7	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
				495		$V_{GS} = -4.5V$, $I_{D} = -400mA$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	_	690	mΩ	$V_{GS} = -2.5V, I_D = -300mA$	
				960		$V_{GS} = -1.8V, I_{D} = -100mA$	
Forward Transfer Admittance	YFS	50	_	_	ms	$V_{DS} = -3V, I_{D} = -300 \text{mA}$	
Diode Forward Voltage	VsD	_	_	-1.2	V	V _G S = 0V, I _S = -300mA	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	76.5	_	pF	101/11/	
Output Capacitance	Coss	_	13.7	_	pF	V _{DS} = -10V, V _{GS} = 0V, -f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	10.7	_	pF	1 = 1.000112	
Gate Resistance	Rg	_	195	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	1.5	_	nC	V _G S = -8V, V _D S = -15V, I _D = -1A	
Total Gate Charge	Qg	_	1.0	_	nC	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Gate-Source Charge	Qgs	_	0.2	_	nC	Vgs = -4.5V, Vds = -15V,	
Gate-Drain Charge	Qgd	_	0.3	_	nC	I _D = -1A	
Turn-On Delay Time	t _D (ON)	_	7.1	_	ns		
Turn-On Rise Time	t _R	_	8.0	_	ns	V _{DS} = -10V, -I _D = 1A	
Turn-Off Delay Time	tD(OFF)	_	31.7	_	ns	$V_{GS} = -4.5V$, $R_g = 6\Omega$	
Turn-Off Fall Time	tF	_	18.5	_	ns		

Notes:

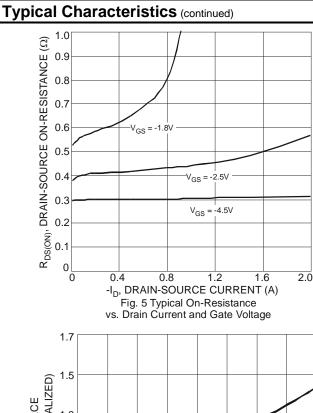
- 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.

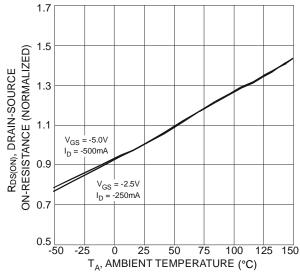
Typical Characteristics

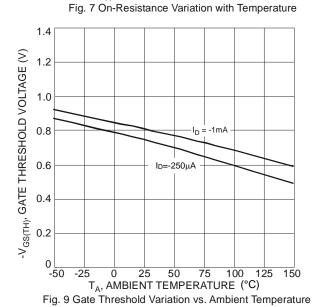


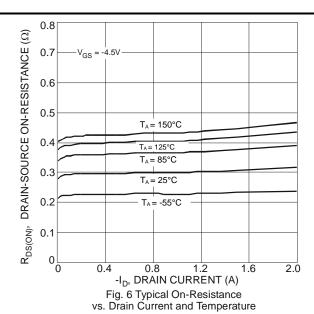


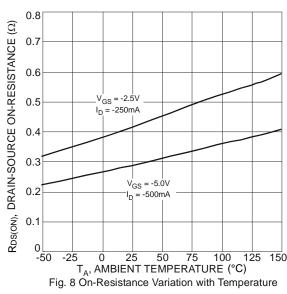


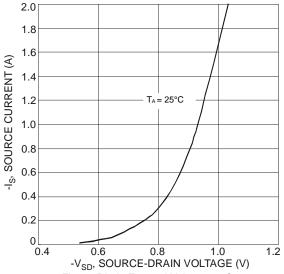






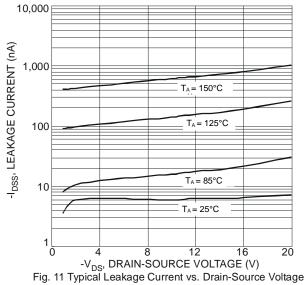


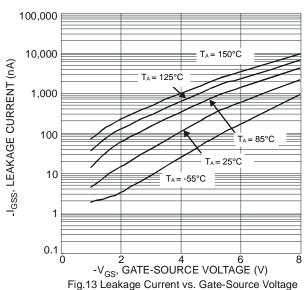




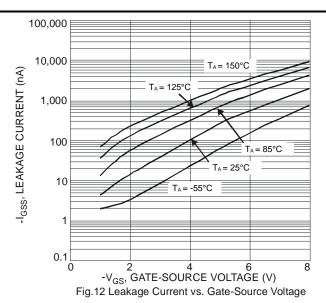


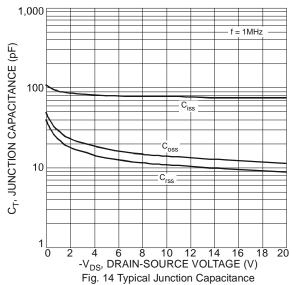
Typical Characteristics (continued)





8 -V_{GS}, GATE-SOURCE VOLTAGE (V) V_{DS} = -15V 2 0. 0.4 0.6 0.8 1.0 1.2 Q_g, TOTAL GATE CHARGE (nC) Fig. 15 Gate-Charge Characteristics



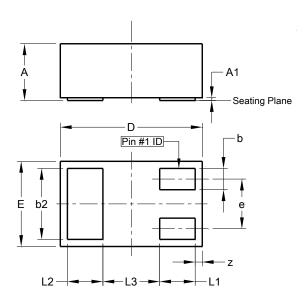




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3

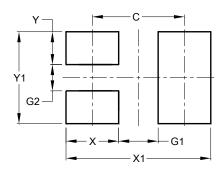


X2-DFN1006-3						
Dim	Min	Max	Тур			
Α	_	0.40				
A1	0.00	0.05	0.03			
b	0.10	0.20	0.15			
b2	0.45	0.55	0.50			
D	0.95	1.05	1.00			
Е	0.55	0.65	0.60			
е			0.35			
L1	0.20	0.30	0.25			
L2	0.20	0.30	0.25			
L3			0.40			
z	0.02	0.08	0.05			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3

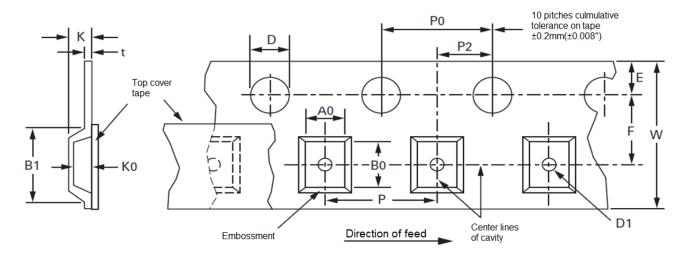


Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Y	0.25
Y1	0.70



Embossed Carrier Tape Specifications

Please see http://www.diodes.com/package-outlines.html for the latest version.



Tape Width (W)	Dimension	Value (mm)	Dimension	Value (mm)	Dimension	Value (mm)
	B1	4.5 max.	F	3.5±0.05	P2	2.0±0.05
	D	1.5+0.10 -0.0	K	2.4 max.	t	0.40 max.
8mm	D1	0.35 min.	P 4.0±0.10 2.0±0.05(-7B)		w	8±0.30
	E	1.75±0.10	P0	4.0±0.10		
	A0 B0 K0	Determined by component size. The clearance between the component and the cavity must compl to the rotational and lateral movement requirement provided in figures in the "Maximum Componer Movement in Tape Pocket" section.				



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